

EAST Search History

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|-------|---------|--|-----------------|------------------|---------|------------------|
| S1 | 4 | ("20020117517" "6284113" "6375871" "5561208").PN. | US-PGPUB; USPAT | ADJ | ON | 2008/10/02 09:10 |
| S2 | 1742 | (438/455).CCL.S. | US-PGPUB; USPAT | OR | OFF | 2008/10/02 15:32 |
| S3 | 1742 | 438/455.ccls. | US-PGPUB; USPAT | ADJ | ON | 2008/10/02 15:33 |
| S4 | 73 | S3 and organic solvent | US-PGPUB; USPAT | ADJ | ON | 2008/10/02 15:34 |
| S5 | 68 | S4 and @ad<"20060616" | US-PGPUB; USPAT | ADJ | ON | 2008/10/02 15:35 |
| S6 | 591 | 438/456 | US-PGPUB; USPAT | ADJ | ON | 2008/10/02 15:41 |
| S7 | 356 | 438/456.ccls. | US-PGPUB; USPAT | ADJ | ON | 2008/10/02 15:41 |
| S8 | 0 | 438/456.clas. | US-PGPUB; USPAT | ADJ | ON | 2008/10/02 15:44 |
| S9 | 356 | 438/456.ccls. | US-PGPUB; USPAT | ADJ | ON | 2008/10/02 15:44 |
| S10 | 591 | 438/456 | US-PGPUB; USPAT | ADJ | ON | 2008/10/02 15:45 |
| S11 | 2870879 | bond\$4 seal\$4 adher\$4 adhes\$ coher\$4 stick cling cleave fast cohes\$4 | US-PGPUB; USPAT | OR | ON | 2008/10/06 15:28 |
| S12 | 3645043 | substrate board chip base foundation wafer | US-PGPUB; USPAT | OR | ON | 2008/10/06 15:29 |
| S13 | 431581 | organic same solvent | US-PGPUB; USPAT | OR | ON | 2008/10/06 15:29 |
| S14 | 466553 | corona plasma | US-PGPUB; USPAT | OR | ON | 2008/10/06 15:29 |
| S15 | 1379976 | ketone (aromatic hydrocarbon) (cyanoacrylate compound) (halogenated hydrocarbon) | US-PGPUB; USPAT | OR | ON | 2008/10/06 15:30 |
| S16 | 1322989 | acetone chloroform (methylene chloride) ethylcyanoacrylate (carbon tetrachloride) | US-PGPUB; USPAT | OR | ON | 2008/10/06 15:32 |
| S17 | 1325707 | acetone chloroform (methylene chloride) ethylcyanoacrylate (carbon tetrachloride) | US-PGPUB; USPAT | OR | ON | 2008/10/06 15:33 |
| S18 | 1115592 | polycarbonate polystyrene polypropylene (polyethylene derivativ\$3) polymethylmethacrylate | US-PGPUB; USPAT | OR | ON | 2008/10/06 15:35 |
| S19 | 3668706 | substrate board chip base foundation wafer | US-PGPUB; USPAT | OR | ON | 2008/10/06 15:37 |
| S20 | 1115738 | polycarbonate polystyrene polypropylene (polyethylene derivativ\$3) polymethylmethacrylate | US-PGPUB; USPAT | OR | ON | 2008/10/06 15:39 |
| S21 | 852565 | S19 and S20 | US-PGPUB; USPAT | OR | ON | 2008/10/06 15:39 |
| S22 | 2570665 | bond\$4 seal\$4 adher\$4 adhes\$4 stick cling cleave fasten cohes\$4 coher\$4 | US-PGPUB; USPAT | OR | ON | 2008/10/06 15:40 |
| S23 | 644501 | S21 and S22 | US-PGPUB; USPAT | OR | ON | 2008/10/06 15:41 |

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|-----|---------|---|--------------------|----|----|---------------------|
| S24 | 431581 | organic same solvent | US-PGPUB; USPAT | OR | ON | 2008/10/06 15:41 |
| S25 | 297929 | (ketone (aromatic hydrocarbon) (cyanoacrylate compound) (halogenated hydrocarbon)) AND (organic NEAR solvent) | US-PGPUB; USPAT | OR | ON | 2008/10/06 15:44 |
| S26 | 1323014 | acetone chloroform (methylene chloride) ethylcyanoacrylate (carbon tetrachloride) | US-PGPUB; USPAT | OR | ON | 2008/10/06 15:46 |
| S27 | 3668706 | substrate board chip base foundation wafer | US-PGPUB; USPAT | OR | ON | 2008/10/06 15:54 |
| S28 | 1115738 | polycarbonate polystyrene polypropylene (polyethylene derivativ\$3) polymethylmethacrylate | US-PGPUB; USPAT | OR | ON | 2008/10/06 15:54 |
| S29 | 852565 | S27 and S28 | US-PGPUB; USPAT | OR | ON | 2008/10/06 15:54 |
| S30 | 2570665 | bond\$4 seal\$4 adher\$4 adhes\$4 stick cling cleave fasten cohes\$4 coher\$4 | US-PGPUB; USPAT | OR | ON | 2008/10/06 15:54 |
| S31 | 644501 | S29 and S30 | US-PGPUB; USPAT | OR | ON | 2008/10/06 15:54 |
| S32 | 364411 | S31 and @pd<"20031218" | US-PGPUB; USPAT | OR | ON | 2008/10/06 15:54 |
| S33 | 431581 | organic same solvent | US-PGPUB; USPAT | OR | ON | 2008/10/06 15:57 |
| S34 | 466553 | corona plasma | US-PGPUB; USPAT | OR | ON | 2008/10/06 15:57 |
| S35 | 89506 | S33 and S34 | US-PGPUB; USPAT | OR | ON | 2008/10/06 15:59 |
| S36 | 295072 | (ketone (aromatic hydrocarbon) (cyanoacrylate compound) (halogenated hydrocarbon)) AND (organic adj solvent) | US-PGPUB; USPAT | OR | ON | 2008/10/06 16:01 |
| S37 | 320348 | organic adj solvent | US-PGPUB; USPAT | OR | ON | 2008/10/06 16:02 |
| S38 | 2870879 | bond\$4 seal\$4 adher\$ adhes\$ coher\$4 stick cling cleave fast cohes\$4 | US-PGPUB; USPAT | OR | ON | 2008/10/06 16:04 |
| S39 | 3645043 | substrate board chip base fondation wafer | US-PGPUB; USPAT | OR | ON | 2008/10/06 16:04 |
| S40 | 1951633 | S38 and S39 | US-PGPUB; USPAT | OR | ON | 2008/10/06 16:04 |
| S41 | 320348 | organic adj solvent | US-PGPUB; USPAT | OR | ON | 2008/10/06 16:06 |
| S42 | 1115738 | polycarbonate polystyrene polypropylene (polyethylene derivativ\$3) polymethylmethacrylate | US-PGPUB; USPAT | OR | ON | 2008/10/06 16:06 |
| S43 | 2516186 | bond\$3 seal\$3 adher\$3 adhes\$3 stick cling cleave fasten coher\$3 cohes\$3 | US-PGPUB; USPAT | OR | ON | 2008/10/06 16:08 |
| S44 | 3668706 | substrate board chip base foundation wafer | US-PGPUB; USPAT | OR | ON | 2008/10/06 16:08 |
| S45 | 1714126 | S43 and S44 | US-PGPUB; USPAT | OR | ON | 2008/10/06 16:09 |
| S46 | 320348 | organic adj solvent | US-PGPUB; USPAT | OR | ON | 2008/10/06 16:09 |
| S47 | 205876 | S45 and S46 | US-PGPUB; USPAT | OR | ON | 2008/10/06 16:09 |
| S48 | 466553 | corona plasma | US-PGPUB; USPAT | OR | ON | 2008/10/06 16:10 |
| S49 | 54926 | S47 and S48 | US-PGPUB; USPAT | OR | ON | 2008/10/06 16:10 |

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| S50 | 326212 | ketone (aromatic adj hydrocarbon) (cyanoacrylate adj compound) (halogenated adj hydrocarbon) | US-PGPUB; USPAT | OR | ON | 2008/10/06 16:11 |
| S51 | 25858 | S49 and S50 | US-PGPUB; USPAT | OR | ON | 2008/10/06 16:11 |
| S52 | 265165 | acetone chloroform (methylene adj chloride) ethylcyanoacrylate (carbon adj tetrachloride) | US-PGPUB; USPAT | OR | ON | 2008/10/06 16:13 |
| S53 | 410167 | acetone chloroform (methylene adj chloride) ethylcyanoacrylate (carbon adj tetrachloride) | US-PGPUB; USPAT | OR | ON | 2008/10/06 16:13 |
| S54 | 18780 | S51 and S53 | US-PGPUB; USPAT | OR | ON | 2008/10/06 16:13 |
| S55 | 357663 | polycarbonate polystyrene polypropylene (polyethylene adj derivativ\$3) polymethylmethacrylate | US-PGPUB; USPAT | OR | ON | 2008/10/06 16:15 |
| S56 | 10207 | S55 and S54 | US-PGPUB; USPAT | OR | ON | 2008/10/06 16:15 |
| S57 | 4296 | S56 and @pd<"20031218" | US-PGPUB; USPAT | OR | ON | 2008/10/06 16:16 |
| S58 | 28 | S57 and "438".das. | US-PGPUB; USPAT | OR | ON | 2008/10/06 16:18 |
| S59 | 10207 | S56 and pd<"20041217" | US-PGPUB; USPAT | OR | ON | 2008/10/06 16:26 |
| S60 | 188 | S59 and "438".das. | US-PGPUB; USPAT | OR | ON | 2008/10/06 16:26 |
| S61 | 2 | ((("6284113") or ("6375871"))).PN. | US-PGPUB; USPAT | OR | OFF | 2008/10/07 09:57 |
| S62 | 2834854 | bond\$3 seal\$3 adher\$3 adhes\$3 coher\$3 stick cling cleave fasten cohes\$ | EPO; JPO; DERWENT | OR | ON | 2008/10/07 10:07 |
| S63 | 4879489 | substrate board chip base foundation wafer | EPO; JPO; DERWENT | OR | ON | 2008/10/07 10:09 |
| S64 | 758663 | S62 and S63 | EPO; JPO; DERWENT | OR | ON | 2008/10/07 10:09 |
| S65 | 176233 | polycarbonate polystyrene polypropylene (polyethylene adj derivative\$3) polymethylmethacrylate | EPO; JPO; DERWENT | OR | ON | 2008/10/07 10:11 |
| S66 | 15570 | S64 and S65 | EPO; JPO; DERWENT | OR | ON | 2008/10/07 10:12 |
| S67 | 177040 | organic adj solvent | EPO; JPO; DERWENT | OR | ON | 2008/10/07 10:12 |
| S68 | 123300 | ketone (aromatic adj hydrocarbon) (cyanoacrylate adj compound) (halogenated adj hydrocarbon) | EPO; JPO; DERWENT | OR | ON | 2008/10/07 10:13 |
| S69 | 286258 | S67 or S68 | EPO; JPO; DERWENT | OR | ON | 2008/10/07 10:14 |
| S70 | 101762 | acetone chloroform (methylene adj chloride) ethylcyanoacrylate (carbon adj tetrachloride) | EPO; JPO; DERWENT | OR | ON | 2008/10/07 10:15 |
| S71 | 361404 | S69 or S70 | EPO; JPO; DERWENT | OR | ON | 2008/10/07 10:15 |
| S72 | 2008 | S66 and S71 | EPO; JPO; DERWENT | OR | ON | 2008/10/07 10:16 |
| S73 | 1041 | S72 and @pd<"20031218" | EPO; JPO; DERWENT | OR | ON | 2008/10/07 10:17 |
| S74 | 1186652 | channel (fine adj channel) dissolve melt | EPO; JPO; DERWENT | OR | ON | 2008/10/07 10:24 |
| S75 | 135 | S73 and S74 | EPO; JPO; DERWENT | OR | ON | 2008/10/07 10:24 |

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| S76 | 1 | ("4962879").PN. | US-PGPUB; USPAT | OR | OFF | 2008/10/08 09:45 |
| S77 | 2834854 | bond\$3 seal\$3 adher\$3 adhes\$3 coher\$3 stick cling cleave fasten cohes\$ | EPO; JPO; DERWENT | OR | ON | 2008/10/08 10:23 |
| S78 | 4879489 | substrate board chip base foundation wafer | EPO; JPO; DERWENT | OR | ON | 2008/10/08 10:23 |
| S79 | 176233 | polycarbonate polystyrene polypropylene (polyethylene adj derivative\$3) polymethylmethacrylate | EPO; JPO; DERWENT | OR | ON | 2008/10/08 10:23 |
| S80 | 0 | S77 and S78 and S79 | US-PGPUB; USPAT | ADJ | ON | 2008/10/08 10:23 |
| S81 | 0 | S78 and S79 | US-PGPUB; USPAT | ADJ | ON | 2008/10/08 10:24 |
| S82 | 302035 | S78 near("10") S79 | EPO; JPO; DERWENT | OR | ON | 2008/10/08 10:25 |
| S83 | 252452 | S78 near("5") S79 | EPO; JPO; DERWENT | OR | ON | 2008/10/08 10:26 |
| S84 | 5010501 | S78 near[5] S79 | EPO; JPO; DERWENT | OR | ON | 2008/10/08 10:26 |
| S85 | 3673777 | S84 and @pd<"20031218" | EPO; JPO; DERWENT | OR | ON | 2008/10/08 10:27 |
| S86 | 56693 | S85 and "438".das. | EPO; JPO; DERWENT | OR | ON | 2008/10/08 10:28 |
| S87 | 9078 | S86 and S77 | EPO; JPO; DERWENT | OR | ON | 2008/10/08 10:29 |
| S88 | 2 | S87 and 438/459.ccls. | EPO; JPO; DERWENT | OR | ON | 2008/10/08 10:33 |
| S89 | 0 | S78 and S79 | US-PGPUB; USPAT | OR | ON | 2008/10/08 10:34 |
| S90 | 0 | S78 near[5] S79 | US-PGPUB; USPAT | OR | ON | 2008/10/08 10:34 |
| S91 | 0 | S78 with S79 | US-PGPUB; USPAT | OR | ON | 2008/10/08 10:35 |
| S92 | 0 | S78 same[3] S79 | US-PGPUB; USPAT | OR | ON | 2008/10/08 10:35 |
| S93 | 0 | S78 adj S79 | US-PGPUB; USPAT | OR | ON | 2008/10/08 10:37 |
| S94 | 0 | S79 and substrate | US-PGPUB; USPAT | OR | ON | 2008/10/08 10:37 |
| S95 | 3647500 | substrate board chip base fondation wafer | US-PGPUB; USPAT | OR | ON | 2008/10/08 10:39 |
| S96 | 1116351 | polycarbonate polystyrene polypropylene (polyethylene derivativ\$3) polymethylmethacrylate | US-PGPUB; USPAT | OR | ON | 2008/10/08 10:39 |
| S97 | 848342 | S95 and S86 | US-PGPUB; USPAT | OR | ON | 2008/10/08 10:39 |
| S98 | 1116351 | polycarbonate polystyrene polypropylene (polyethylene derivativ\$3) polymethylmethacrylate | US-PGPUB; USPAT | OR | ON | 2008/10/08 10:41 |
| S99 | 848342 | S95 and S85 | US-PGPUB; USPAT | OR | ON | 2008/10/08 10:41 |
| S100 | 3671174 | substrate board chip base foundation wafer | US-PGPUB; USPAT | OR | ON | 2008/10/08 10:43 |
| S101 | 1116351 | polycarbonate polystyrene polypropylene (polyethylene derivativ\$3) polymethylmethacrylate | US-PGPUB; USPAT | OR | ON | 2008/10/08 10:44 |

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|------|---------|--|--------------------|-----|----|---------------------|
| S102 | 853078 | S100 and S101 | US-PGPUB; USPAT | ADJ | ON | 2008/10/08 10:44 |
| S103 | 1116351 | S101 and S101 | US-PGPUB; USPAT | ADJ | ON | 2008/10/08 10:45 |
| S104 | 18 | S103 and 438/456.ccls. | US-PGPUB; USPAT | ADJ | ON | 2008/10/08 10:46 |
| S105 | 18 | S104 and @py<"20031218" | US-PGPUB; USPAT | ADJ | ON | 2008/10/08 10:47 |
| S106 | 853078 | S100 and S101 | US-PGPUB; USPAT | ADJ | ON | 2008/10/08 11:11 |
| S107 | 3671174 | substrate board chip base foundation wafer | US-PGPUB; USPAT | OR | ON | 2008/10/08 11:13 |
| S108 | 1116351 | polycarbonate polystyrene polypropylene (polyethylene derivativ\$3) polymethylmethacrylate | US-PGPUB; USPAT | OR | ON | 2008/10/08 11:13 |
| S109 | 853078 | S107 and S108 | US-PGPUB; USPAT | ADJ | ON | 2008/10/08 11:13 |
| S110 | 498775 | S109 and @pd<"20031218" | US-PGPUB; USPAT | ADJ | ON | 2008/10/08 11:13 |
| S111 | 3122 | S110 and "438".clas. | US-PGPUB; USPAT | ADJ | ON | 2008/10/08 11:14 |
| S112 | 31 | S111 and 438/455.ccls. | US-PGPUB; USPAT | ADJ | ON | 2008/10/08 11:16 |
| S113 | 146185 | corona\$4 | US-PGPUB; USPAT | OR | ON | 2008/10/08 15:58 |
| S114 | 1 | "20070141805".pn. | US-PGPUB; USPAT | OR | ON | 2008/10/08 15:59 |
| S115 | 1 | S113 and S114 | US-PGPUB; USPAT | OR | ON | 2008/10/08 15:59 |
| S116 | 935202 | solvent ketone (aromatic adj hydrocarbon) (cyanoacrylate adj compound) (halogenated adj hydrocarbon) acetone chloroform (methylene adj chloride) ethlcynoacrylate (carbon adj tetrachloride) | US-PGPUB; USPAT | OR | ON | 2008/10/09 10:51 |
| S117 | 1446623 | plastic polycarbonate polystyrene polypropylene (polyethylene adj derivativ\$3) polymethylmethacrylate | US-PGPUB; USPAT | OR | ON | 2008/10/09 10:53 |
| S118 | 21974 | S117 and "3" with (corona\$4 or plasma) | US-PGPUB; USPAT | OR | ON | 2008/10/09 10:54 |
| S119 | 326 | S117 and S116 with (corona\$4 and plasma) | US-PGPUB; USPAT | OR | ON | 2008/10/09 10:55 |
| S120 | 326 | S119 and @py<"20031217" | US-PGPUB; USPAT | OR | ON | 2008/10/09 10:57 |
| S121 | 138 | S119 and @pd<"20031217" | US-PGPUB; USPAT | OR | ON | 2008/10/09 10:58 |
| S122 | 1 | S121 not solvent | US-PGPUB; USPAT | OR | ON | 2008/10/09 11:35 |
| S123 | 551495 | ketone (aromatic adj hydrocarbon) (cyanoacrylate adj compound) (halogenated adj hydrocarbon) acetone chloroform (methylene adj chloride) ethlcynoacrylate (carbon adj tetrachloride) | US-PGPUB; USPAT | OR | ON | 2008/10/09 11:35 |
| S124 | 1259 | S117 and S123 with (corona\$4 or plasma) | US-PGPUB; USPAT | OR | ON | 2008/10/09 11:36 |
| S125 | 652 | S124 and @pd<"20031217" | US-PGPUB; USPAT | OR | ON | 2008/10/09 11:37 |

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|------|---------|--|--------------------|----|-----|---------------------|
| S126 | 20 | S125 and "438".clas. | US-PGPUB; USPAT | OR | ON | 2008/10/09 11:37 |
| S127 | 1 | ("6425972").PN. | US-PGPUB; USPAT | OR | OFF | 2008/10/10 11:13 |
| S128 | 1093442 | transparen\$4 clear see-through invisible penetrable | US-PGPUB; USPAT | OR | ON | 2008/10/14 08:20 |
| S129 | 3677614 | substrate board chip base foundation wafer | US-PGPUB; USPAT | OR | ON | 2008/10/14 08:20 |
| S130 | 788695 | S128 and S129 | US-PGPUB; USPAT | OR | ON | 2008/10/14 08:20 |
| S131 | 15632 | S130 and "438".clas. | US-PGPUB; USPAT | OR | ON | 2008/10/14 08:21 |
| S132 | 7734 | S131 and @pd < "20031217" | US-PGPUB; USPAT | OR | ON | 2008/10/14 08:22 |
| S133 | 15 | S132 and 438/456.ccls. | US-PGPUB; USPAT | OR | ON | 2008/10/14 08:24 |
| S134 | 23664 | S128.ab. | US-PGPUB; USPAT | OR | ON | 2008/10/14 08:26 |
| S135 | 14676 | S134 and S129 | US-PGPUB; USPAT | OR | ON | 2008/10/14 08:27 |
| S136 | 10039 | S135 and @pd< "20031217" | US-PGPUB; USPAT | OR | ON | 2008/10/14 08:27 |
| S137 | 124 | S136 and "438".clas. | US-PGPUB; USPAT | OR | ON | 2008/10/14 08:28 |
| S138 | 2021 | S134 with S129 | US-PGPUB; USPAT | OR | ON | 2008/10/14 08:33 |
| S139 | 3746 | S134 same S129 | US-PGPUB; USPAT | OR | ON | 2008/10/14 08:33 |
| S140 | 73 | S138 and "438".clas. | US-PGPUB; USPAT | OR | ON | 2008/10/14 08:34 |
| S141 | 42 | S140 and @pd< "20031217" | US-PGPUB; USPAT | OR | ON | 2008/10/14 08:35 |
| S142 | 1526467 | transparen\$4 clear see-through invisible penetrable | US-PGPUB; USPAT | OR | ON | 2008/10/14 08:49 |
| S143 | 94290 | S142.ab. | US-PGPUB; USPAT | OR | ON | 2008/10/14 08:49 |
| S144 | 20001 | S143 with S129 | US-PGPUB; USPAT | OR | ON | 2008/10/14 08:49 |
| S145 | 1477 | S144 and "438".clas. | US-PGPUB; USPAT | OR | ON | 2008/10/14 08:50 |
| S146 | 649 | S145 and @pd< "20031217" | US-PGPUB; USPAT | OR | ON | 2008/10/14 08:50 |
| S147 | 1 | S146 and 438/456.ccls. | US-PGPUB; USPAT | OR | ON | 2008/10/14 08:51 |
| S148 | 2521611 | bond\$3 seal\$3 adher\$3 adhes\$3 stick cling cleave fasten coher\$3 cohes\$3 | US-PGPUB; USPAT | OR | ON | 2008/10/15 15:56 |
| S149 | 467943 | corona plasma | US-PGPUB; USPAT | OR | ON | 2008/10/15 15:56 |
| S150 | 410908 | acetone chloroform (methylene adj chloride) ethylcyanoacrylate (carbon adj tetrachloride) | US-PGPUB; USPAT | OR | ON | 2008/10/15 15:56 |
| S151 | 358521 | polycarbonate polystyrene polypropylene (polyethylyene adj derivativ\$3) polymethylmethylnmethacrylate | US-PGPUB; USPAT | OR | ON | 2008/10/15 15:56 |
| S152 | 6 | S151 with S150 with S149 with S148 | US-PGPUB; USPAT | OR | ON | 2008/10/15 15:56 |

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| S153 | 195 | S150 with S151 with S148 | US-PGPUB; USPAT | OR | ON | 2008/10/15 15:58 |
| S154 | 5 | S153 and "438".clas. | US-PGPUB; USPAT | OR | ON | 2008/10/15 15:59 |
| S155 | 195 | S153 and @pyc-"20060616" | US-PGPUB; USPAT | OR | ON | 2008/10/15 16:00 |
| S156 | 1375 | S150 same S151 same S148 | US-PGPUB; USPAT | OR | ON | 2008/10/15 16:01 |
| S157 | 1375 | S156 and @pyc-"20060616" | US-PGPUB; USPAT | OR | ON | 2008/10/15 16:02 |
| S158 | 12 | S157 and "438".clas. | US-PGPUB; USPAT | OR | ON | 2008/10/15 16:02 |
| S159 | 37 | S157 and "257".clas. | US-PGPUB; USPAT | OR | ON | 2008/10/15 16:19 |
| S160 | 468649 | corona plasma | US-PGPUB; USPAT | OR | ON | 2008/10/16 06:58 |
| S161 | 411289 | acetone chloroform (methylene adj chloride) ethylcyanoacrylate (carbon adj tetrachloride) | US-PGPUB; USPAT | OR | ON | 2008/10/16 06:58 |
| S162 | 358958 | polycarbonate polystyrene polypropylene (polyethylyene adj derivativ\$3) polymethylmethylnmethacrylate | US-PGPUB; USPAT | OR | ON | 2008/10/16 06:58 |
| S163 | 15 | S162 with S161 with S160 | US-PGPUB; USPAT | ADJ | ON | 2008/10/16 06:58 |
| S164 | 2524260 | bond\$3 seal\$3 adher\$3 adhes\$3 stick cling cleave fasten coher\$3 cohes\$3 | US-PGPUB; USPAT | OR | ON | 2008/10/16 06:59 |
| S165 | 6 | S163 with S164 | US-PGPUB; USPAT | ADJ | ON | 2008/10/16 06:59 |
| S166 | 170 | S162 same S161 same S160 | US-PGPUB; USPAT | ADJ | ON | 2008/10/16 07:00 |
| S167 | 2835541 | bond\$3 seal\$3 adher\$3 adhes\$3 coher\$3 stick cling cleave fasten cohes\$ | EPO; JPO; DERWENT | OR | ON | 2008/10/16 07:02 |
| S168 | 0 | S166 same S167 | US-PGPUB; USPAT | ADJ | ON | 2008/10/16 07:02 |
| S169 | 52 | S166 same (bond\$4 seal\$4 adher\$4 adhes \$4 stick cling cleave fasten cohes\$4 coher \$4) | US-PGPUB; USPAT | OR | ON | 2008/10/16 07:03 |
| S170 | 0 | 438/456.ccls and (corona plasma) | US-PGPUB; USPAT | OR | ON | 2008/10/16 07:08 |
| S171 | 0 | 438/454.ccls and (corona plasma) | US-PGPUB; USPAT | OR | ON | 2008/10/16 07:09 |
| S172 | 15 | S162 with S161 with S160 | US-PGPUB; USPAT | OR | ON | 2008/10/16 07:11 |
| S173 | 0 | S162 with S161 with S160 | EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2008/10/16 08:44 |
| S174 | 0 | S162 same S161 same S160 | EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2008/10/16 08:44 |
| S175 | 102037 | acetone chloroform (methylene adj chloride) ethylcyanoacrylate (carbon adj tetrachloride) | EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2008/10/16 08:45 |
| S176 | 176381 | polycarbonate polystyrene polypropylene (polyethylyene adj derivativ\$3) polymethylmethylnmethacrylate | EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2008/10/16 08:46 |

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| S177 | 290550 | corona plasma | EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2008/10/16 08:47 |
| S178 | 2842960 | bond\$3 seal\$3 adher\$3 adhes\$3 coher\$3 stick cling cleave fasten cohes\$ | EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2008/10/16 08:48 |
| S179 | 757 | S177 same S175 | EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2008/10/16 08:49 |
| S180 | 13020 | S176 with S178 | EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2008/10/16 08:49 |
| S181 | 5 | S179 and S180 | EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2008/10/16 08:50 |
| S182 | 1790 | S161 with S160 | US-PGPUB; USPAT | OR | ON | 2008/10/16 08:59 |
| S183 | 1437 | S182 and @pd<"20060616" | US-PGPUB; USPAT | OR | ON | 2008/10/16 09:00 |
| S184 | 3 | S183 and 438/455.ccls. | US-PGPUB; USPAT | OR | ON | 2008/10/16 09:01 |
| S185 | 247 | S183 and "438".clas. | US-PGPUB; USPAT | OR | ON | 2008/10/16 09:02 |
| S186 | 1513 | S177 same S176 | EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2008/10/16 09:10 |
| S187 | 53 | S186 and S175 | EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2008/10/16 09:11 |
| S188 | 0 | S160 with S162 | EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2008/10/16 09:12 |
| S189 | 2015 | S160 with S162 | US-PGPUB; USPAT | OR | ON | 2008/10/16 09:13 |
| S190 | 735 | S189 and S161 | US-PGPUB; USPAT | OR | ON | 2008/10/16 09:13 |
| S191 | 599 | S190 and @pd<"20060616" | US-PGPUB; USPAT | OR | ON | 2008/10/16 09:14 |
| S192 | 16 | S190 and "438".clas. | US-PGPUB; USPAT | OR | ON | 2008/10/16 09:14 |
| S193 | 1 | ("4485171").PN. | US-PGPUB; USPAT | OR | OFF | 2008/10/20 09:00 |

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